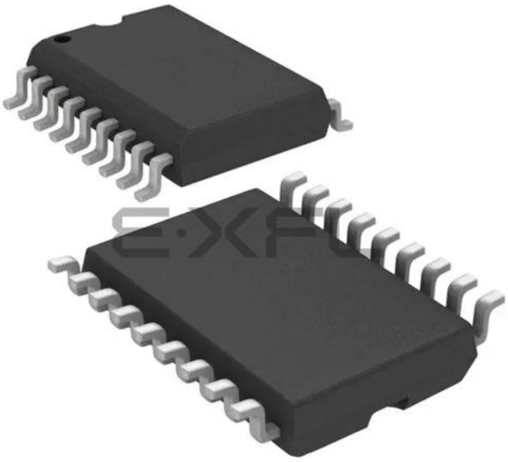


What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Discontinued at Digi-Key
Core Processor	Z8
Core Size	8-Bit
Speed	10MHz
Connectivity	-
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	14
Program Memory Size	1KB (1K x 8)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	64 x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	18-SOIC (0.295", 7.50mm Width)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z8pe003sz010sc

ABSOLUTE MAXIMUM RATINGS

Parameter	Min	Max	Units	Note
Ambient Temperature under Bias	–40	+105	C	
Storage Temperature	–65	+150	C	
Voltage on any Pin with Respect to V_{SS}	–0.6	+7	V	1
Voltage on V_{DD} Pin with Respect to V_{SS}	–0.3	+7	V	
Voltage on PB5 Pin with Respect to V_{SS}	–0.6	V_{DD}+1	V	2
Total Power Dissipation		880	mW	
Maximum Allowable Current out of V_{SS}		40	mA	3
Maximum Allowable Current into V_{DD}		40	mA	3
Maximum Allowable Current into an Input Pin	–600	+600	µA	4
Maximum Allowable Current into an Open-Drain Pin	–600	+600	µA	5
Maximum Allowable Output Current Sunk by Any I/O Pin		25	mA	
Maximum Allowable Output Current Sourced by Any I/O Pin		25	mA	
Maximum Allowable Output Current Sunk by Port A		40	mA	3
Maximum Allowable Output Current Sourced by Port A		40	mA	3
Maximum Allowable Output Current Sunk by Port B		40	mA	3
Maximum Allowable Output Current Sourced by Port B		40	mA	3

Notes:
1. Applies to all pins except the PB5 pin and where otherwise noted.
2. There is no input protection diode from pin to V_{DD}.
3. Peak Current. Do not exceed 25mA average current in either direction.
4. Excludes XTAL pins.
5. Device pin is not at an output Low state.

Stresses greater than those listed under Absolute Maximum Ratings can cause permanent damage to the device. This rating is a stress rating only. Functional operation of the device at any condition above those indicated in the operational sections of these specifications is not implied. Exposure to absolute maximum rating conditions for an extended period can affect device reliability. Total power dissipation should not exceed 880 mW for the package. Power dissipation is calculated as follows:

$$\text{Total Power Dissipation} = V_{DD} \times [I_{DD} - (\text{sum of } I_{OH})] + \text{sum of } [(V_{DD} - V_{OH}) \times I_{OH}] + \text{sum of } (V_{OL} \times I_{OL})$$

DC ELECTRICAL CHARACTERISTICS (Continued)

Table 6. DC Electrical Characteristics

			T_A = –40°C to +105°C Extended Temperatures					
Sym	**Parameter**	**V_{CC}[1]**	**Min**	**Max**	**Typical[2] @ 25°C**	**Units**	**Conditions**	**Notes**
V_{CH}	Clock Input High Voltage	4.5V	0.7 V_{CC}	V_{CC}+0.3	2.5	V	Driven by External Clock Generator	
		5.5V	0.7 V_{CC}	V_{CC}+0.3	2.5	V	Driven by External Clock Generator	
V_{CL}	Clock Input Low Voltage	4.5V	V_{SS}–0.3	0.2 V_{CC}	1.5	V	Driven by External Clock Generator	
		5.5V	V_{SS}–0.3	0.2 V_{CC}	1.5	V	Driven by External Clock Generator	
V_{IH}	Input High Voltage	4.5V	0.7 V_{CC}	V_{CC}+0.3	2.5	V		
		5.5V	0.7 V_{CC}	V_{CC}+0.3	2.5	V		
V_{IL}	Input Low Voltage	4.5V	V_{SS}–0.3	0.2 V_{CC}	1.5	V		
		5.5V	V_{SS}–0.3	0.2 V_{CC}	1.5	V		
V_{OH}	Output High Voltage	4.5V	V_{CC}–0.4		4.8	V	I_{OH} = –2.0 mA	
		5.5V	V_{CC}–0.4		4.8	V	I_{OH} = –2.0 mA	
V_{OL1}	Output Low Voltage	4.5V		0.4	0.1	V	I_{OL} = +4.0 mA	
		5.5V		0.4	0.1	V	I_{OL} = +4.0 mA	
V_{OL2}	Output Low Voltage	4.5V		1.2	0.5	V	I_{OL} = +12 mA	
		5.5V		1.2	0.5	V	I_{OL} = +12 mA	
V_{OFFSET}	Comparator Input Offset Voltage	4.5V		25.0	10.0	mV		
		5.5V		25.0	10.0	mV		
I_{IL}	Input Leakage	4.5V	–1.0	2.0	<1.0	µA	V_{IN} = 0V, V_{CC}	
		5.5V	–1.0	2.0	<1.0	µA	V_{IN} = 0V, V_{CC}	
I_{OL}	Output Leakage	4.5V	–1.0	2.0	<1.0	µA	V_{IN} = 0V, V_{CC}	
		5.5V	–1.0	2.0	<1.0	µA	V_{IN} = 0V, V_{CC}	
V_{ICR}	Comparator Input Common Mode Voltage Range	4.5V	0	V_{CC} –1.5V		V		3
		5.5V	0	V_{CC} –1.5V		V		3
R_{PB5}	PB5 Pull-up Resistor	4.5V	100		200	kOhm		4
		5.5V	100		200			
V_{LV}	V_{CC} Low-Voltage Protection		2.45	2.85	2.60	V		
I_{CC}	Supply Current	4.5V		7.0	4.0	mA	@ 10 MHz	5,6
		5.5V		7.0	4.0	mA	@ 10 MHz	5,6

Notes:
1. The V_{CC} voltage specification of 4.5V and 5.5V guarantees 5.0V ±0.5V.
2. Typical values are measured at V_{CC} = 5.0V; V_{SS} = 0V = GND.
3. For analog comparator input when analog comparator is enabled.
4. No protection diode is provided from the pin to V_{CC}. External protection is recommended.
5. All outputs are unloaded and all inputs are at V_{CC} or V_{SS} level.
6. CL1 = CL2 = 22 pF.
7. Same as note 5, except inputs are at V_{CC}.

Table 6. DC Electrical Characteristics (Continued)

Sym	Parameter	V_{CC}[1]	$T_A = -40°C$ to $+105°C$ Extended Temperatures Min	Max	Typical[2] @ 25°C	Units	Conditions	Notes
I_{CC1}	Standby Current	4.5V		2.0	1.0	mA	HALT mode V_{IN} = 0V, V_{CC} @ 10 MHz	5,6
		5.5V		2.0	1.0	mA	HALT mode V_{IN} = 0V, V_{CC} @ 10 MHz	5,6
I_{CC2}	Standby Current	4.5V		700	250	nA	STOP mode V_{IN} = 0V,V_{CC}	7
		5.5V		700	250	nA	STOP mode V_{IN} = 0V,V_{CC}	7

Notes:
1. The V_{CC} voltage specification of 4.5V and 5.5V guarantees 5.0V ±0.5V.
2. Typical values are measured at V_{CC} = 5.0V; V_{SS} = 0V = GND.
3. For analog comparator input when analog comparator is enabled.
4. No protection diode is provided from the pin to V_{CC}. External protection is recommended.
5. All outputs are unloaded and all inputs are at V_{CC} or V_{SS} level.
6. CL1 = CL2 = 22 pF.
7. Same as note 5, except inputs are at V_{CC}.

AC ELECTRICAL CHARACTERISTICS

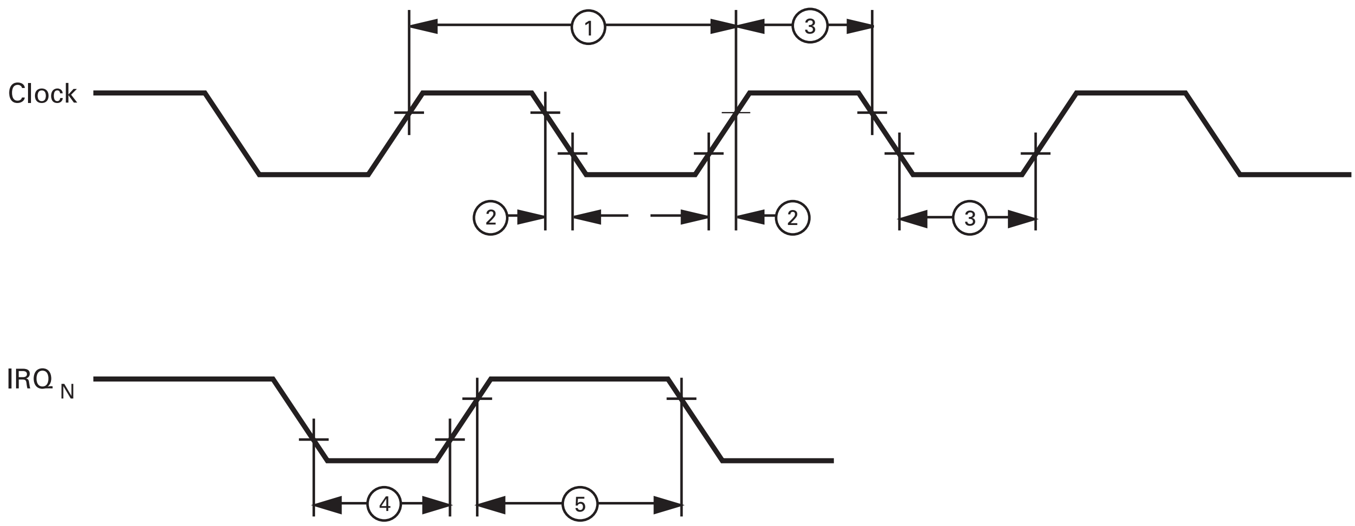


Figure 8. AC Electrical Timing Diagram

Table 7. Additional Timing

				T_A = 0°C to +70°C T_A = –40°C to +105°C @ 10 MHz			
No	**Symbol**	**Parameter**	**V_{CC}[1]**	**Min**	**Max**	**Units**	**Notes**
1	T_PC	Input Clock Period	3.0V	100	DC	ns	2
			5.5V	100	DC	ns	2
2	T_RC,T_FC	Clock Input Rise and Fall Times	3.0V		15	ns	2
			5.5V		15	ns	2
3	T_WC	Input Clock Width	3.0V	50		ns	2
			5.5V	50		ns	2
4	T_WIL	Int. Request Input Low Time	3.0V	70		ns	2
			5.5V	70		ns	2
5	T_WIH	Int. Request Input High Time	3.0V	5TpC			2
			5.5V	5TpC			2
6	T_{WSM}	STOP mode Recovery Width Spec.	3.0V	25		ns	
			5.5V	25		ns	
7	T_{OST}	Oscillator Start-Up Time	3.0V		5TpC		
			5.5V		5TpC		
8	T_{POR}	Power-On Reset Time	3.0V	128 T_PC + T_{OST}			
			5.5V				

Notes:
1. The V_{DD} voltage specification of 3.0V guarantees 3.0V. The V_{DD} voltage specification of 5.5V guarantees 5.0V ±0.5V.
2. Timing Reference uses 0.7 V_{CC} for a logical 1 and 0.2 V_{CC} for a logical 0.

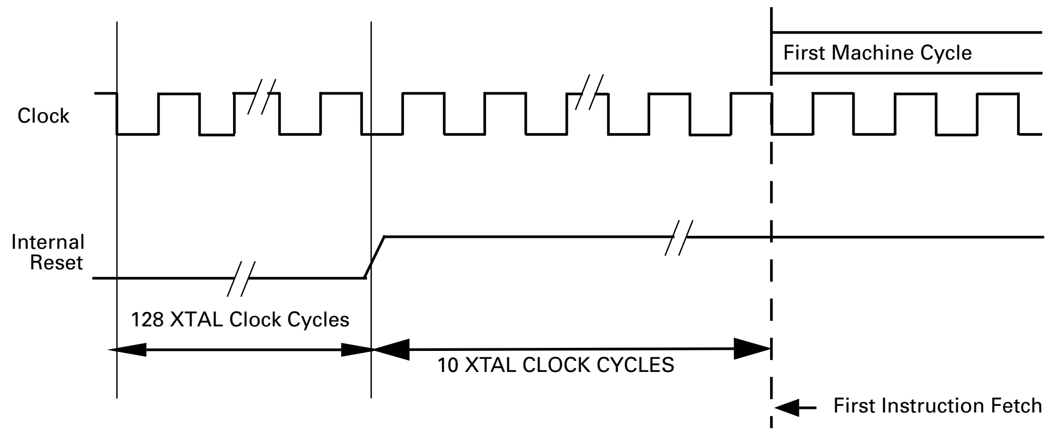


Figure 9. Reset Timing

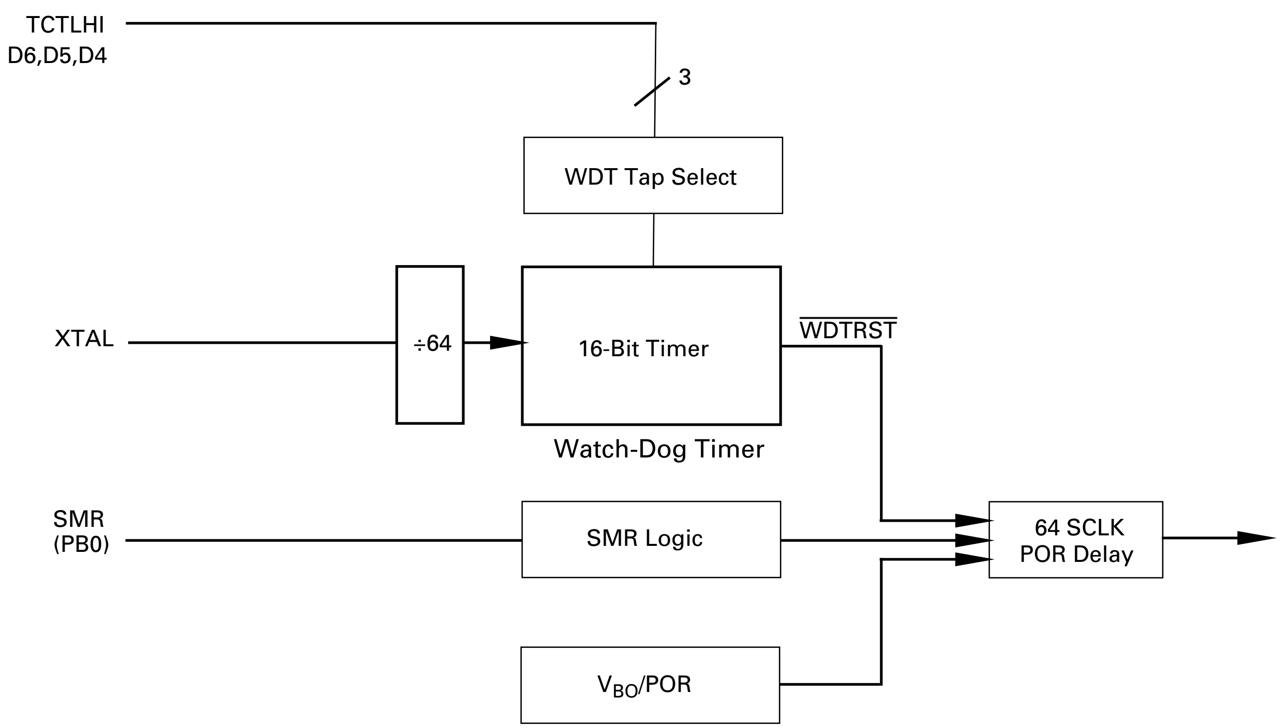


Figure 10. Reset Circuitry with POR, WDT, V_{BO}, and SMR

STOP MODE OPERATION

The STOP mode provides the lowest possible device standby current. This instruction turns off the on-chip oscillator and internal system clock.

To enter the STOP mode, the Z8Plus only requires a STOP instruction. It is *not* necessary to execute a NOP instruction immediately before the STOP instruction.

```
6F   STOP   ;enter STOP mode
```

The STOP mode is exited by any one of the following resets: POR or a Stop-Mode Recovery source. At reset generation, the processor always restarts the application program at address 0020H, and the STOP mode flag is set. Reading the STOP mode flag does not clear it. The user must clear the STOP mode flag with software.

Note: Failure to clear the STOP mode flag can result in undefined behavior.

The Z8Plus provides a dedicated Stop-Mode Recovery (SMR) circuit. In this case, a low-level applied to input pin PB0 (I/O Port B, bit 0) triggers an SMR. To use this mode, pin PB0 must be configured as an input and the special function selected before the STOP mode is entered. The Low level on PB0 must be held for a minimum pulse width T_{WSM}. Program execution starts at address 20h, after the POR delay.

Notes: 1. The PB0 input, when used for Stop-Mode Recovery, does not initialize the control registers.

The STOP mode current (I_{CC2}) is minimized when:

- V_{CC} is at the low end of the device's operating range
- Output current sourcing is minimized
- All inputs (digital and analog) are at the Low or High rail voltages

2. For detailed information about flag settings, see the Z8Plus User's Manual.

CLOCK

The Z8Plus MCU derives its timing from on-board clock circuitry connected to pins XTAL1 and XTAL2. The clock circuitry consists of an oscillator, a glitch filter, and a divide-by-two shaping circuit. Figure 12 illustrates the clock circuitry. The oscillator's input is XTAL1 and its output is XTAL2. The clock can be driven by a crystal, a ceramic resonator, LC clock, or an external clock source.

By selecting the RC OSCILLATOR option in the graphical user interface (GUI), the circuit may instead be driven by an external Resistor and Capacitor (RC) oscillator. Figure 13 illustrates this configuration. This design is limited to no more than 4 MHz to restrict EMI noise.

Note: The reduced drive strength of this configuration also allows the clock circuit to use a micropower-type crystal (also known as a tuning fork) without reduction resistors.

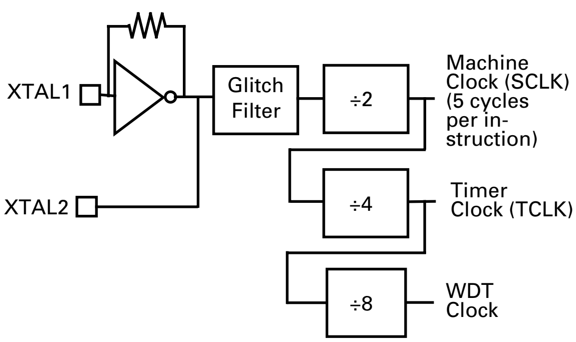


Figure 12. Clock Circuit

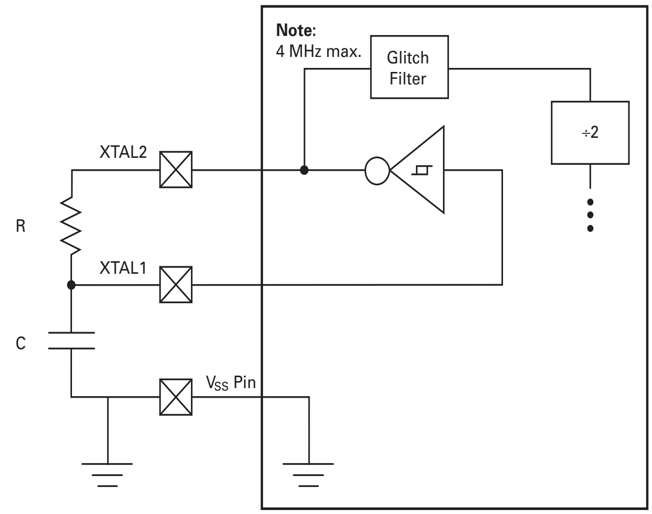


Figure 13. Z8Plus in RC Oscillator Mode

LC OSCILLATOR

The Z8Plus oscillator can use an inductor capacitor oscillator (LC) network to generate an XTAL clock (Figure 17).

The frequency stays stable over V_{CC} and temperature. The oscillation frequency is determined by the equation:

$$\text{Frequency} = \frac{1}{2\pi\,(LC_T)^{1/2}}$$

where L is the total inductance including parasitics, and C_T is the total series capacitance including parasitics.

Simple series capacitance is calculated using the equation at the top of the next column.

$$\begin{aligned} 1/C_T &= 1/C_1 + 1/C_2 \\ \text{If } C_1 &= C_2 \\ 1/C_T &= 2/C_1 \\ C_1 &= 2C_T \end{aligned}$$

A sample calculation of capacitance C_1 and C_2 for 5.83-MHz frequency and inductance value of 27 µH is displayed as follows:

$$5.83\ (10\hat{\ }6) = \frac{1}{2\pi\,[27\ (10^{-6})\ C_T]^{1/2}}$$

$$C_T = 27.6 \text{ pF}$$

Thus, C_1 = 55.2 pF and C_2 = 55.2 pF.

TIMERS

Two 8-bit timers, timer 0 (T0) and timer 1 (T1) are available to function as a pair of independent 8-bit standard timers. They may also be cascaded to function as a 16-bit Pulse-Width Modulator (PWM) timer. Two additional 8-bit timers (T2 and T3) are provided, but they can only operate as one 16-bit standard timer.

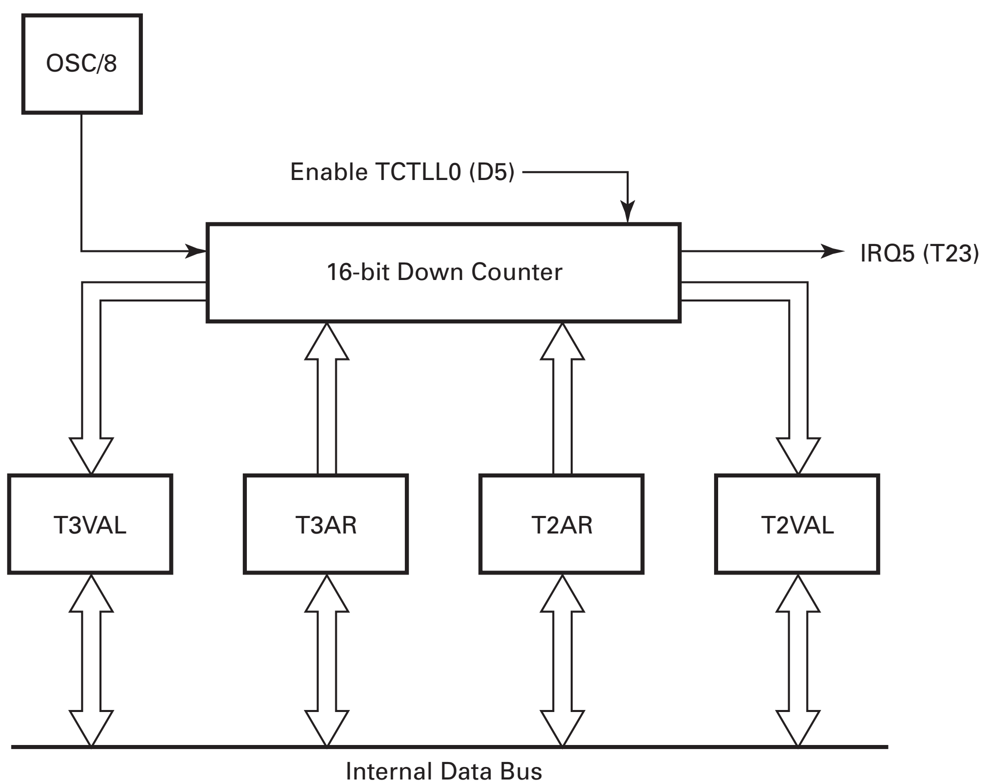


Figure 19. 16-Bit Standard Timer

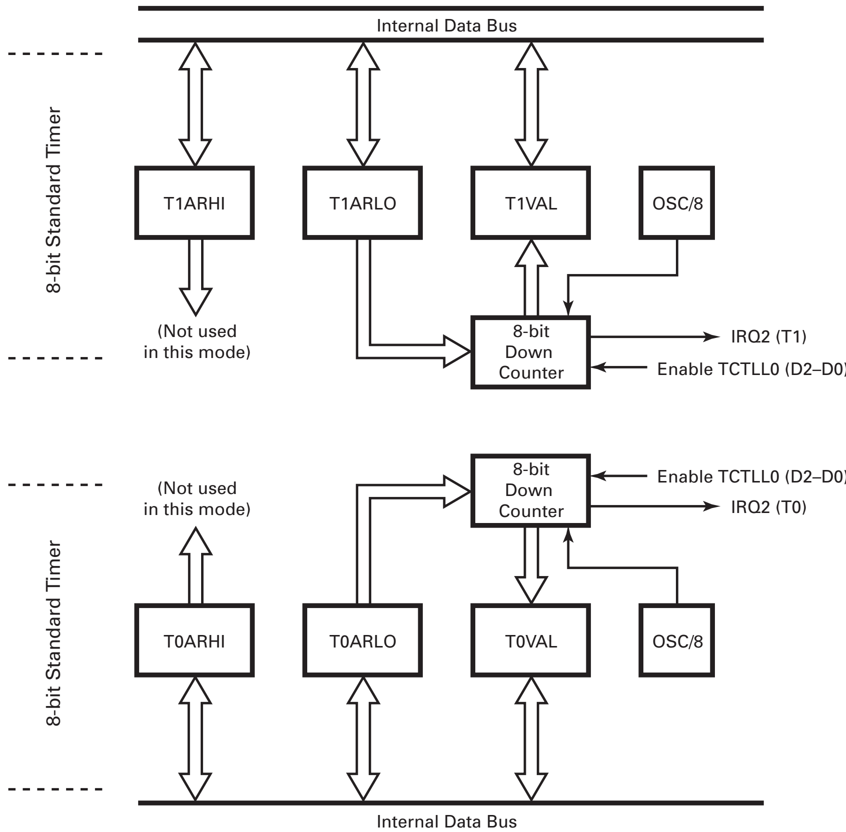


Figure 20. 8-Bit Standard Timers

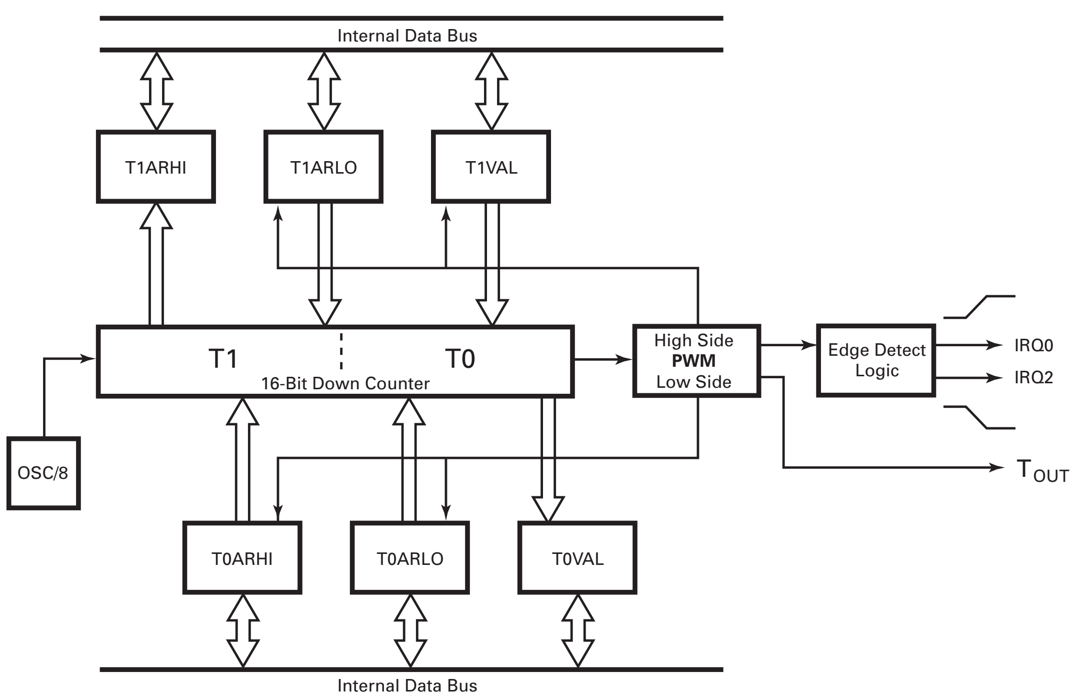


Figure 21. 16-Bit Standard PWM Timer

TIMERS (Continued)

0C0 TCTLLO

D7	D6	D5	D4	D3	D2	D1	D0

D2–D0: TIMER STATUS

D2	D1	D0	T0	T1	T01
0	0	0	Disabled	Disabled	
0	0	1	Enabled	Disabled	
0	1	0	Disabled	Enabled	
0	1	1	Enabled	Enabled	
1	0	0			Enabled*
1	0	1	Enabled*	Disabled	
1	1	0	Disabled	Enabled*	
1	1	1	Enabled*	Enabled*	

NOTE: (*) indicates auto-reload is active.

D4–D3: Reserved (must be 0)

D5: 1 = T23 16-Bit Timer Enabled with Auto-Reload Active
0 = T2 and T3 Timers Disabled

D7–D6: Reserved (must be 0)

Note: Timer T01 is a 16-bit PWM Timer formed by cascading 8-bit timers T1 (MSB) and T0 (LSB). T23 is a standard 16-bit timer formed by cascading 8-bit timers T3 (MSB) and T2 (LSB).

Figure 22. TCTLLO Register

A pair of READ/WRITE registers is utilized for each 8-bit timer. One register is defined to contain the auto-initialization value for the timer. The second register contains the current value for the timer. When a timer is enabled, the timer decrements the value in its count register and continues decrementing until it reaches `0`. An interrupt is generated, and the contents of the auto-initialization register are optionally copied into the count value register. If auto-initialization is not enabled, the timer stops counting when the value reaches `0`. Control logic clears the appropriate control register bit to disable the timer. This operation is referred to as a *single-shot*. If auto-initialization is enabled, the timer counts from the initialization value. Software must not attempt to use timer registers for any other function.

User software is allowed to write to any WRITE register at any time; however, care should be taken if timer registers are updated while the timer is enabled. If software changes the count value while the timer is in operation, the timer continues counting from the updated value.

Note: Unpredictable behavior can occur if the value updates at the same time that the timer reaches `0`.

Similarly, if user software changes the initialization value register while the timer is active, the next time that the timer reaches `0`, the timer initializes to the changed value.

Note: Unpredictable behavior can occur if the initialization value register is changed while the timer is in the process of being initialized.

The initialization value is determined by the exact timing of the WRITE operation. In all cases, the Z8Plus assigns a higher priority to the software WRITE than to a decrementer write-back. However, when hardware clears a control register bit for a timer that is configured for single-shot operation, the clearing of the control bit overrides a software WRITE. A READ of either register can be conducted at any time, with no effect on the functionality of the timer.

TIMERS (Continued)

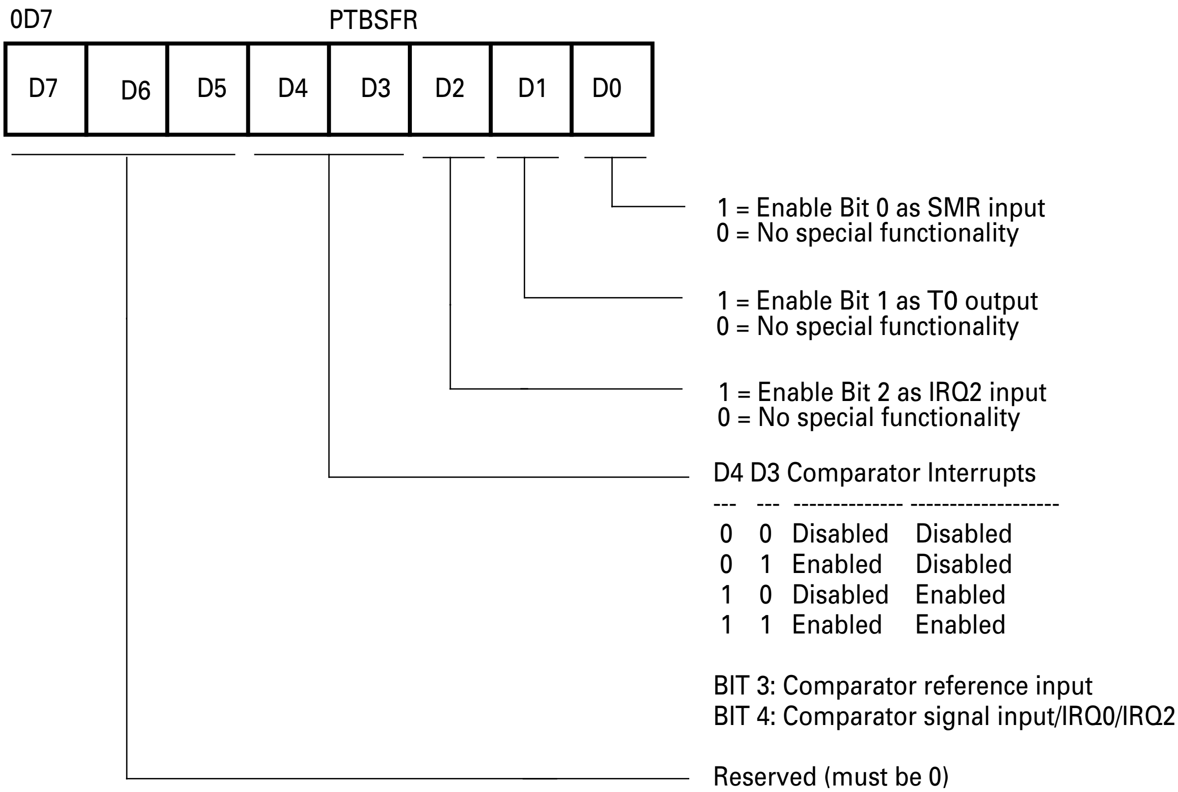


Figure 23. PortB Special Function Register

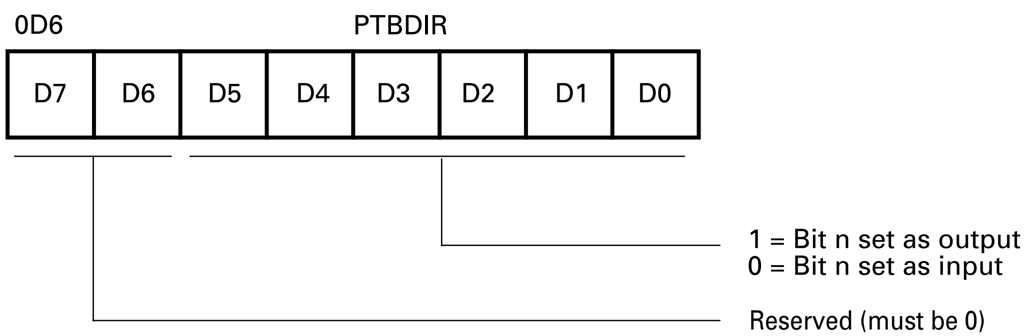


Figure 24. Port B Directional Control Register

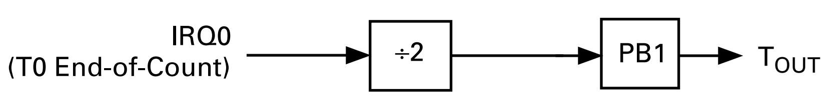


Figure 25. Timer T0 Output Through T_{OUT}

for that bit position contains the current synchronized input value.

For port bits configured as an output by means of the directional control register, the value held in the corresponding bit of the Output Value Register is driven directly onto the output pin. The opposite register bit for a given pin (the output register bit for an input pin and the input register bit for an output pin) holds their previous value. These bits are not changed and do not exhibit any effect on the hardware.

READ/WRITE OPERATIONS

The control for each port is done on a bit-by-bit basis. All bits are capable of operating as inputs or outputs, depending on the setting of the port's directional control register. If configured as an input, each bit is provided a Schmitt-trigger. The output of the Schmitt-trigger is latched twice to perform a synchronization function, and the output of the synchronizer is fed to the port input register, which can be read by software.

A WRITE to a port input register carries the effect of updating the contents of the input register, but subsequent READs do not necessarily return the same value that was written. If the bit in question is defined as an input, the input register for that bit position contains the current synchronized input value. WRITEs to that bit position are overwritten on the next clock cycle with the newly sampled input data. However, if the particular bit is programmed as an output, the input register for that bit retains the software-updated value. The port bits that are programmed as outputs do not sample the value being driven out.

Any bit in either port can be defined as an output by setting the appropriate bit in the directional control register. In this instance, the value held in the appropriate bit of the port output register is driven directly onto the output pin.

Note: The preceding result does not necessarily reflect the actual output value. If an external error is holding an output pin either High or Low against the output driver, the software READ returns the *requested* value, not the actual state caused by the contention. When a bit is defined as an output, the Schmitt-trigger on the input is disabled to save power.

Updates to the output register take effect based on the timing of the internal instruction pipeline; however, this timing is referenced to the rising edge of the clock. The output register can be read at any time, and returns the current output value that is held. No restrictions are placed on the timing of READs and/or WRITEs to any of the port registers with respect to the others.

Note: Care should be taken when updating the directional control and special function registers.

When updating a directional control register, the special function register (SFR) should first be disabled. If this precaution is not taken, unpredicted events could occur as a result of the change in the port I/O status. This precaution is especially important when defining changes in Port B, as the unpredicted event referred to above could be one or more interrupts. Clearing of the SFR register should be the first step in configuring the port, while setting the SFR register should be the final step in the port configuration process. To ensure unpredictable results, the SFR register should not be written until the pins are being driven appropriately, and all initialization is completed.

PORT A

Port A is a general-purpose port. Figure 27 features a block diagram of Port A. Each of its lines can be independently programmed as input or output via the Port A directional control register (PTADIR at 0D2H) as seen in Figure 26. A bit set to a 1 in PTADIR configures the corresponding bit in Port A as an output, while a bit cleared to 0 configures the corresponding bit in Port A as an input.

The input buffers are Schmitt-triggered. Bits programmed as outputs can be individually programmed as either push-pull or open-drain by setting the corresponding bit in the special function register (PTASFR, Figure 26).

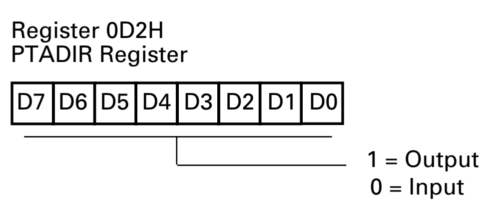


Figure 27. Port A Directional Control Register

PORT A REGISTER DIAGRAMS

Register 0D0H PTAIN

D7	D6	D5	D4	D3	D2	D1	D0

Port A Bit n current input value
(only updated for pins in input mode)

Figure 28. Port A Input Value Register

Register 0D1H PTAOUT

D7	D6	D5	D4	D3	D2	D1	D0

Port A Bit n currentoutput value

Figure 29. Port A Output Value Register

Register 0D2H PTADIR

D7	D6	D5	D4	D3	D2	D1	D0

1 = Bit n set as an output
0 = Bit n set as an input

Figure 30. Port A Directional Control Register

Register 0D3H PTASFR

D7	D6	D5	D4	D3	D2	D1	D0

1 = Bit n in open-drain mode
0 = Bit n in push-pull mode

Figure 31. Port A Special Function Register

PORT B—PIN 2 CONFIGURATION

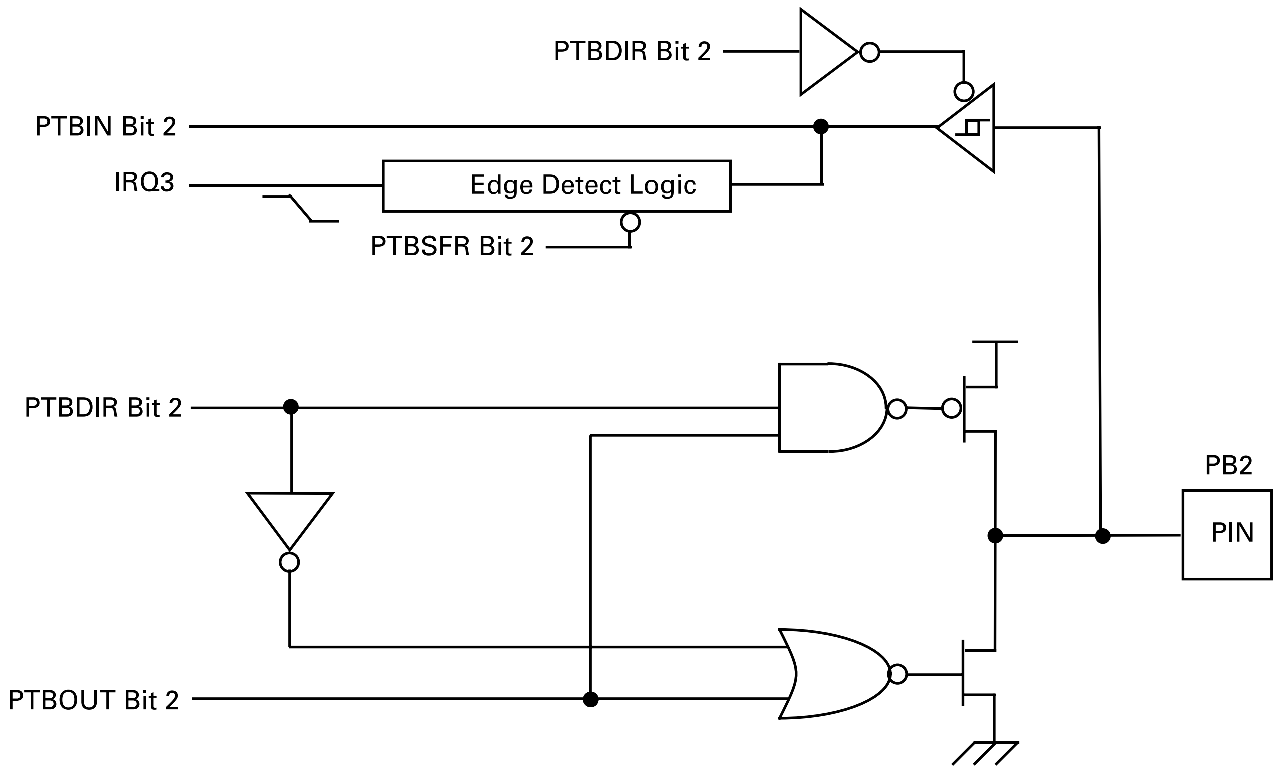


Figure 36. Port B Pin 2 Diagram

PORT B CONTROL REGISTERS (Continued)

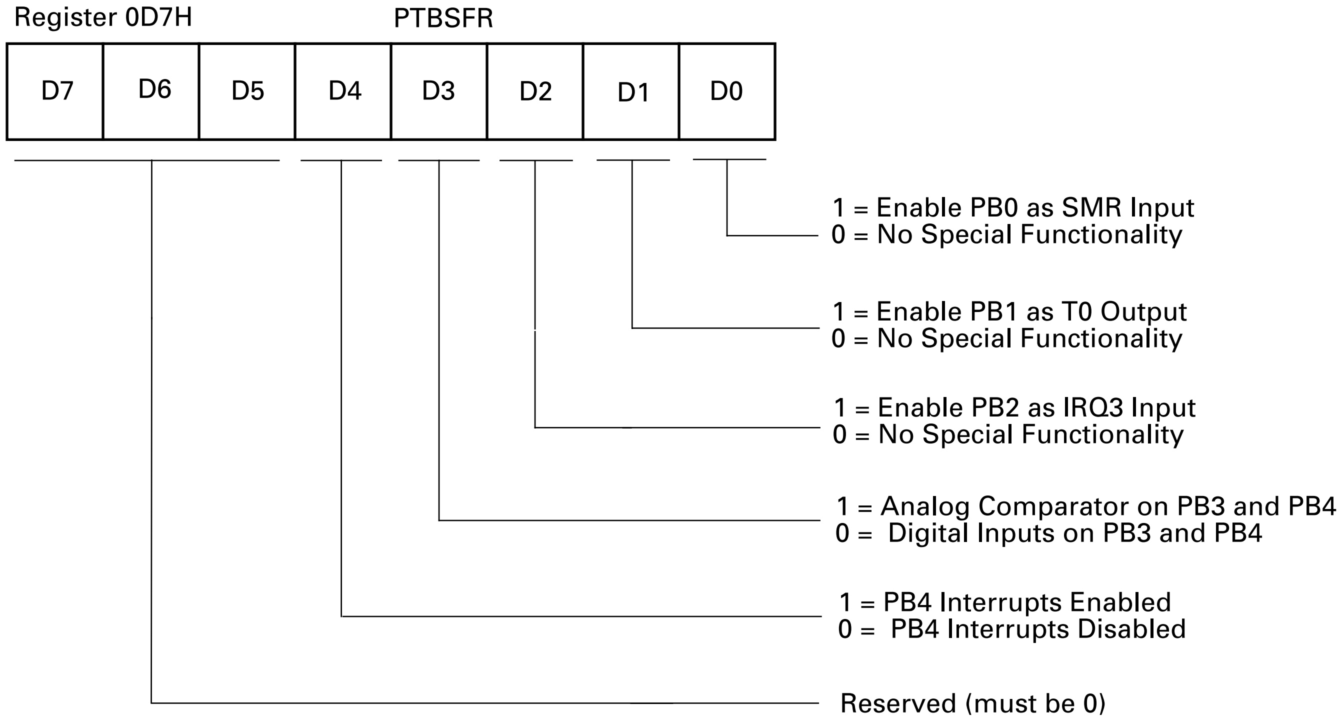


Figure 41. Port B Special Function Register

COMPARATOR OPERATION (Continued)

age Protection trip point (V_{LV}) is reached. The actual Low-Voltage Protection trip point is a function of process parameters.

Low-Voltage Protection is active in RUN and HALT modes only, but is disabled in STOP mode (Figure 42).

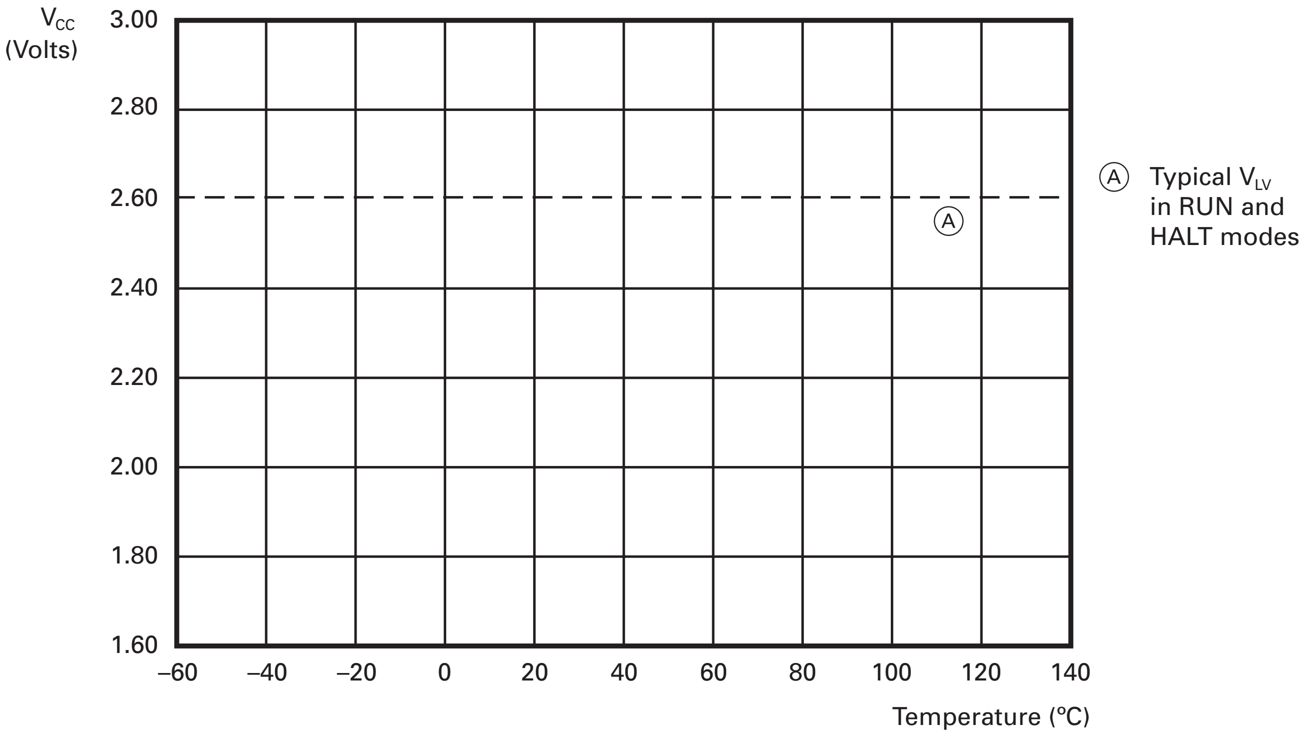


Figure 42. Typical Low Voltage Protection vs. Temperature

INPUT PROTECTION

All I/O pins feature diode input protection. There is a diode from the I/O pad to V_{CC} and V_{SS} (Figure 43).

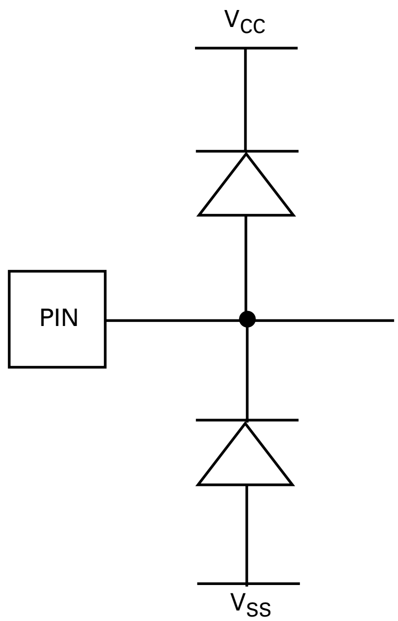


Figure 43. I/O Pin Diode Input Protection

However, the PB5 pin features only the input protection diode, from the pad to V_{SS} (Figure 44).

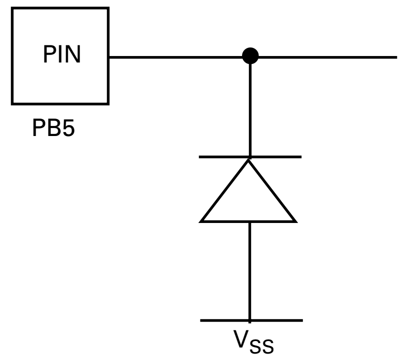
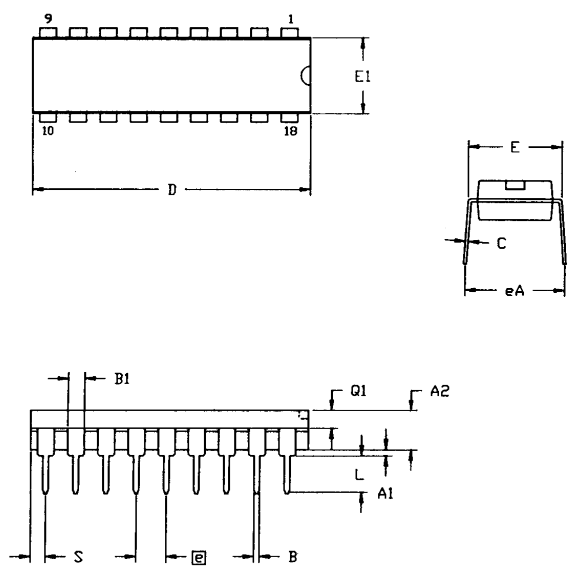


Figure 44. PB5 Pin Input Protection

The high-side input protection diode was removed on this pin to allow the application of high voltage during the OTP programming mode.

For better noise immunity in applications that are exposed to system EMI, a clamping diode to V_{SS} from this pin should be used to prevent entering the OTP programming mode or to prevent high voltage from damaging this pin.

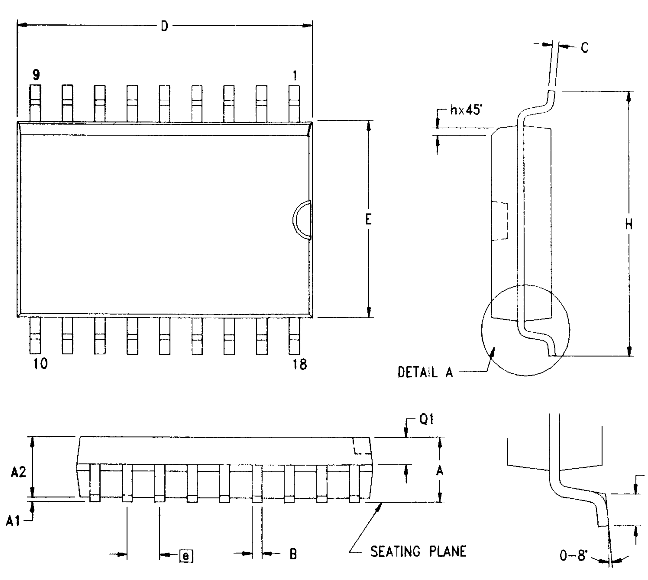
PACKAGE INFORMATION



SYMBOL	MILLIMETER		INCH	
	MIN	MAX	MIN	MAX
A1	0.51	0.81	.020	.032
A2	3.25	3.43	.128	.135
B	0.38	0.53	.015	.021
B1	1.14	1.65	.045	.065
C	0.23	0.38	.009	.015
D	22.35	23.37	.880	.920
E	7.62	8.13	.300	.320
E1	6.22	6.48	.245	.255
e	2.54 TYP		.100 TYP	
eA	7.87	8.89	.310	.350
L	3.18	3.81	.125	.150
Q1	1.52	1.65	.060	.065
S	0.89	1.65	.035	.065

CONTROLLING DIMENSIONS : INCH

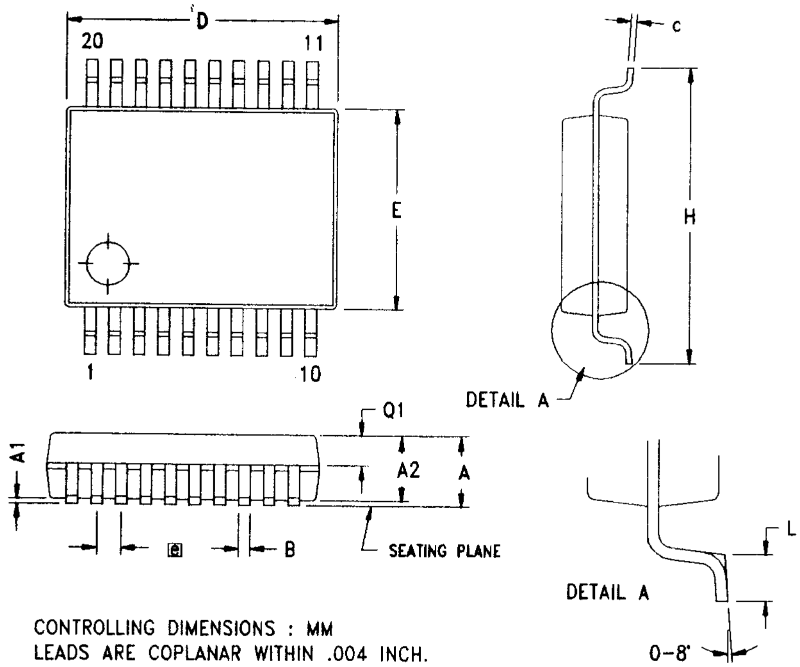
Figure 45. 18-Pin DIP Package Diagram



SYMBOL	MILLIMETER		INCH	
	MIN	MAX	MIN	MAX
A	2.40	2.65	0.094	0.104
A1	0.10	0.30	0.004	0.012
A2	2.24	2.44	0.088	0.096
B	0.36	0.46	0.014	0.018
C	0.23	0.30	0.009	0.012
D	11.40	11.75	0.449	0.463
E	7.40	7.60	0.291	0.299
e	1.27 TYP		0.050 TYP	
H	10.00	10.65	0.394	0.419
h	0.30	0.50	0.012	0.020
L	0.60	1.00	0.024	0.039
Q1	0.97	1.07	0.038	0.042

CONTROLLING DIMENSIONS : MM
LEADS ARE COPLANAR WITHIN .004 INCH.

Figure 46. 18-Pin SOIC Package Diagram



SYMBOL	MILLIMETER			INCH		
	MIN	NOM	MAX	MIN	NOM	MAX
A	1.73	1.85	1.98	0.068	0.073	0.078
A1	0.05	0.13	0.21	0.002	0.005	0.008
A2	1.68	1.73	1.83	0.066	0.068	0.072
B	0.25	0.30	0.38	0.010	0.012	0.015
C	0.13	0.15	0.22	0.005	0.006	0.009
D	7.07	7.20	7.33	0.278	0.283	0.289
E	5.20	5.30	5.38	0.205	0.209	0.212
e	0.65 TYP			0.0256 TYP		
H	7.65	7.80	7.90	0.301	0.307	0.311
L	0.56	0.75	0.94	0.022	0.030	0.037
Q1	0.74	0.78	0.82	0.029	0.031	0.032

Figure 47. 20-Pin SSOP Package Diagram

ORDERING INFORMATION

Standard Temperature	
18-Pin DIP	Z8PE003PZ010SC
18-Pin SOIC	Z8PE003SZ010SC
20-Pin SSOP	Z8PE003HZ010SC
Extended Temperature	
18-Pin DIP	Z8PE003PZ010EC
18-Pin SOIC	Z8PE003SZ010EC
20-Pin SSOP	Z8PE003CZ010EC

For fast results, contact your local ZiLOG sales office for assistance in ordering the part(s) required.

Codes	
Preferred Package	PZ = Plastic DIP
Longer Lead Time	SZ = SOIC
	HZ = SSOP
Speed	010 = 10 MHz
Standard Temperature	S = 0°C to +70°C
Extended Temperature	E = –40°C to +105°C
Environmental Flow	C = Plastic Standard

Example:

The Z8PE003PZ010SC is a 10-MHz DIP, 0ºC to 70ºC, with Plastic Standard Flow.

Z	ZiLOG Prefix
8PE	Z8Plus Product
003	Product Number
PZ	Package Designation Code
010	Speed
SC	Temperature and Environmental Flow

Pre-Characterization Product:

The product represented by this document is newly introduced and ZiLOG has not completed the full characterization of the product. The document states what ZiLOG knows about this product at this time, but additional features or non-conformance with some aspects of the document may be found, either by ZiLOG or its customers in the course of further application and characterization work. In addition, ZiLOG cautions that delivery may be uncertain at times, due to start-up yield issues.

ZiLOG, Inc.
910 East Hamilton Avenue, Suite 110
Campbell, CA 95008
Telephone (408) 558-8500
FAX 408 558-8300
Internet: http://www.zilog.com